

#### Replaces DS5455-4

# DIM1600FSM17-A000

## Single Switch IGBT Module

DS5455-5 October 2021 (LN41241)

## FEATURES

- 10µs Short Circuit Withstand
- High Thermal Cycling Capability
- Non Punch Through Silicon
- Isolated AISiC Base with AIN Substrates
- Lead Free construction

## **APPLICATIONS**

- High Reliability Inverters
- Motor Controllers
- Traction Drives

The Powerline range of high power modules includes half bridge, chopper, dual, single and bi-directional switch configurations covering voltages from 1200V to 6500V and currents up to 2400A.

The DIM1600FSM17-A000 is a single switch 1700V, n-channel enhancement mode, insulated gate bipolar transistor (IGBT) module. The IGBT has a wide reverse bias safe operating area (RBSOA) plus 10µs short circuit withstand. This device is optimised for traction drives and other applications requiring high thermal cycling capability.

The module incorporates an electrically isolated base plate and low inductance construction enabling circuit designers to optimise circuit layouts and utilise grounded heat sinks for safety.

## **ORDERING INFORMATION**

Order As:

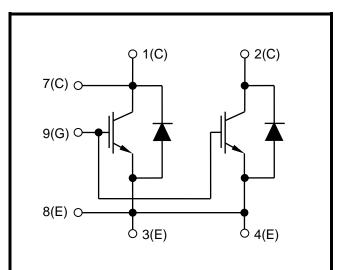
## DIM1600FSM17-A000

Note: When ordering, please use the complete part number

## **KEY PARAMETERS**

VCES		1700V
V <sub>CE(sat)</sub>	* (typ)	2.7V
lc	(max)	1600A
I <sub>C(PK)</sub>	(max)	3200A

\* Measured at the power busbars, not the auxiliary terminals







## **ABSOLUTE MAXIMUM RATINGS**

Stresses above those listed under 'Absolute Maximum Ratings' may cause permanent damage to the device. In extreme conditions, as with all semiconductors, this may include potentially hazardous rupture of the package. Appropriate safety precautions should always be followed. Exposure to Absolute Maximum Ratings may affect device reliability.

#### T<sub>case</sub> = 25°C unless stated otherwise

Symbol	Parameter	Test Conditions	Max.	Units
Vces	Collector-emitter voltage	V <sub>GE</sub> = 0V	1700	V
V <sub>GES</sub>	Gate-emitter voltage		±20	V
Ic	Continuous collector current	T <sub>case</sub> = 75°C	1600	А
IC(PK)	Peak collector current	1ms, T <sub>case</sub> = 110°C	3200	А
P <sub>max</sub>	Max. transistor power dissipation	$T_{case} = 25^{\circ}C, T_j = 150^{\circ}C$	13890	W
l²t	Diode l <sup>2</sup> t value	$V_R = 0, t_p = 10ms, T_j = 125^{\circ}C$	480	kA <sup>2</sup> s
V <sub>isol</sub>	Isolation voltage – per module	Commoned terminals to base plate. AC RMS, 1 min, 50Hz	4000	V
Q <sub>PD</sub>	Partial discharge – per module	IEC1287, $V_1 = 1800V$ , $V_2 = 1300V$ , 50Hz RMS	10	рС

#### THERMAL AND MECHANICAL RATINGS

Internal insulation material:	AIN
Baseplate material:	AlSiC
Creepage distance:	20mm
Clearance:	10mm
CTI (Comparative Tracking Index):	350

Symbol	Parameter	Test Conditions	Min	Тур.	Мах	Units
R <sub>th(j-c)</sub>	Thermal resistance – transistor	Continuous dissipation - junction to case	-	-	9	°C/kW
Rth(j-c)	Thermal resistance – diode	Continuous dissipation - junction to case	-	-	20	°C/kW
Rth(c-h)	Thermal resistance – case to heatsink (per module)	Mounting torque 5Nm (with mounting grease)	-	-	8	°C/kW
Tj	Junction temperature	Transistor	-	-	150	°C
		Diode	-	-	125	°C
T <sub>stg</sub>	Storage temperature range	-	-40	-	125	°C
		Mounting – M6	-	-	5	Nm
	Screw torque	Electrical connections – M4	-	-	2	Nm
		Electrical connections – M8	-	-	10	Nm

## **ELECTRICAL CHARACTERISTICS**

#### T<sub>case</sub> = 25°C unless stated otherwise.

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
		$V_{GE} = 0V, V_{CE} = V_{CES}$			2	mA
I <sub>CES</sub>	Collector cut-off current	$V_{GE} = 0V, V_{CE} = V_{CES}, T_{case} = 125^{\circ}C$			50	mA
IGES	Gate leakage current	$V_{GE} = \pm 20V, V_{CE} = 0V$			8	μA
V <sub>GE(TH)</sub>	Gate threshold voltage	$I_{C} = 80 \text{mA}, V_{GE} = V_{CE}$	4.5	5.5	6.5	V
V +	Collector-emitter	V <sub>GE</sub> = 15V, I <sub>C</sub> = 1600A		2.7	3.2	V
V <sub>CE(sat)</sub> †	saturation voltage	$V_{GE} = 15V, I_C = 1600A, T_j = 125^{\circ}C$		3.4	4.0	V
lF	Diode forward current	DC			1600	А
IFM	Diode maximum forward current	t <sub>p</sub> = 1ms			3200	А
		IF = 1600A		2.2	2.5	V
V <sub>F</sub> †	Diode forward voltage	I <sub>F</sub> = 1600A, T <sub>j</sub> = 125°C		2.3	2.6	V
Cies	Input capacitance	V <sub>CE</sub> = 25V, V <sub>GE</sub> = 0V, f = 1MHz		120		nF
Qg	Gate charge	±15V		18		μC
Cres	Reverse transfer capacitance	V <sub>CE</sub> = 25V, V <sub>GE</sub> = 0V, f = 1MHz				nF
Lм	Module inductance			15		nH
RINT	Internal transistor resistance			140		μΩ
SC <sub>Data</sub>	Short circuit current, Isc	$\begin{split} T_{j} &= 125^{\circ}C, \ V_{CC} &= 1000V \\ t_{p} &\leq 10 \mu s, \ V_{GE} &\leq 15V \\ V_{CE \ (max)} &= V_{CES} - L^{*} \ x \ dl/dt \\ IEC \ 60747-9 \end{split}$		6400		A

#### Note:

 $^{\dagger}\,$  Measured at the power busbars, not the auxiliary terminals  $^{*}\,$  L is the circuit inductance +  $L_{M}$ 

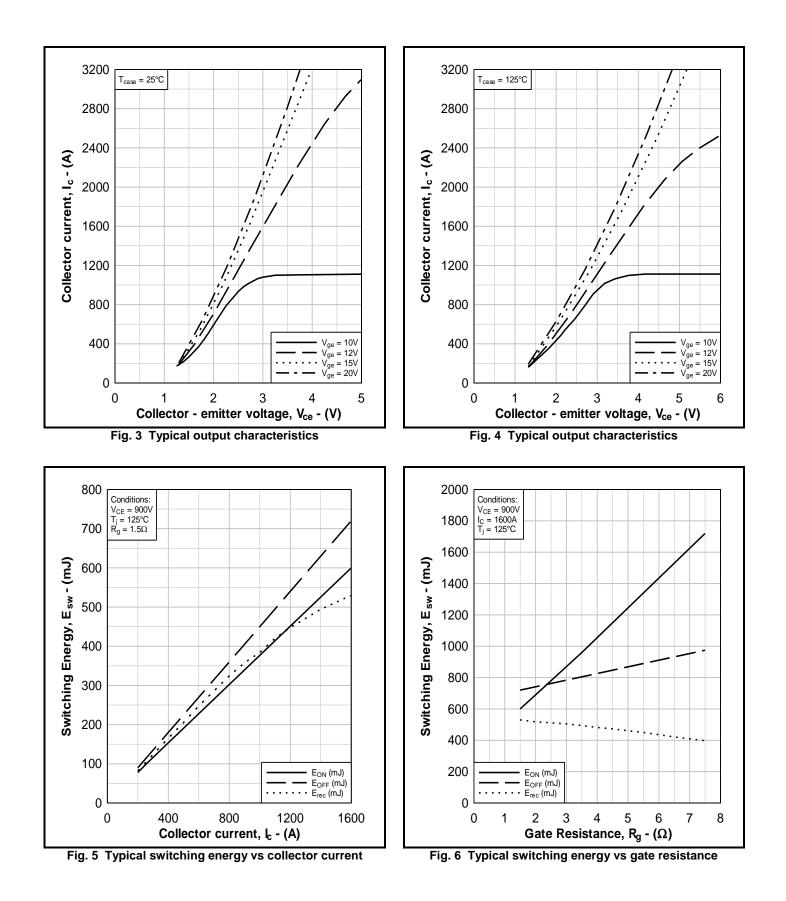
## **ELECTRICAL CHARACTERISTICS**

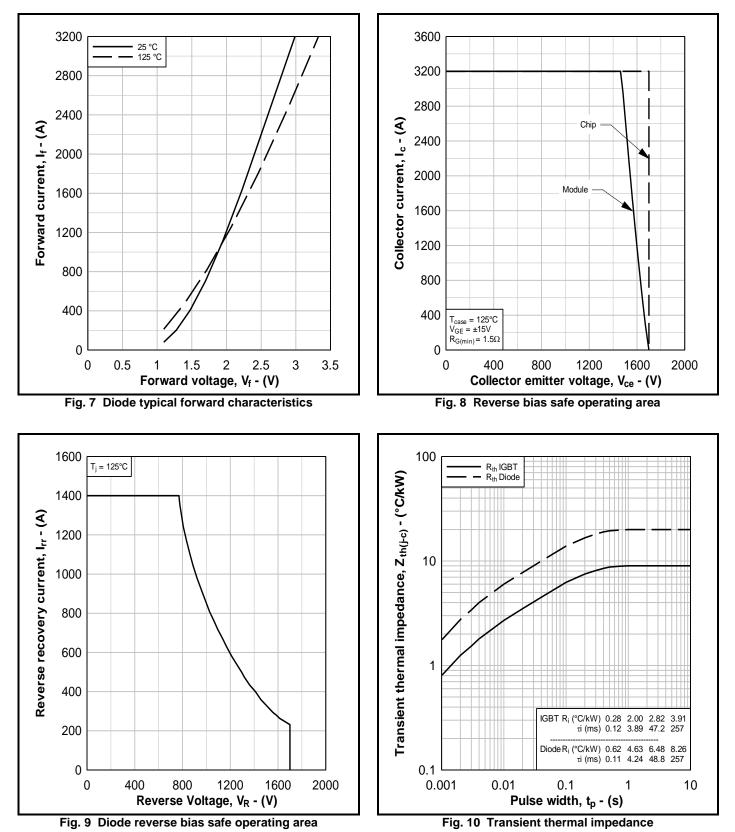
#### T<sub>case</sub> = 25°C unless stated otherwise

Symbol	Parameter	Test Conditions	Min	Тур.	Max	Units
t <sub>d(off)</sub>	Turn-off delay time			1400		ns
t <sub>f</sub>	Fall time	$I_{C} = 1600A$ $V_{GE} = \pm 15V$		200		ns
Eoff	Turn-off energy loss	$V_{CE} = 900V$		550		mJ
t <sub>d(on)</sub>	Turn-on delay time	$R_{G(ON)} = 1.5\Omega$		300		ns
tr	Rise time	$R_{G(OFF)} = 1.5\Omega$ $L_{S} \sim 100 \text{nH}$		200		ns
Eon	Turn-on energy loss			300		mJ
Qrr	Diode reverse recovery charge	I <sub>F</sub> = 1600A		400		μC
Irr	Diode reverse recovery current	$V_{CE} = 900V$		1000		А
Erec	Diode reverse recovery energy	dI <sub>F</sub> /dt = 8000A/µs		265		mJ

#### T<sub>case</sub> = 125°C unless stated otherwise

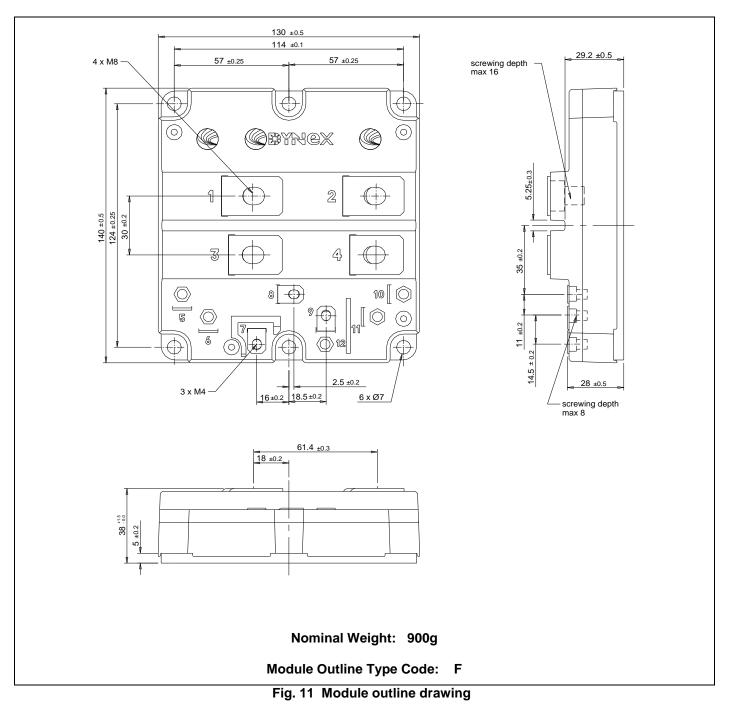
Symbol	Parameter	Test Conditions	Min	Тур.	Max	Units
$t_{d(off)}$	Turn-off delay time			1600		ns
t <sub>f</sub>	Fall time	$I_{C} = 1600A$ $V_{GE} = \pm 15V$		250		ns
EOFF	Turn-off energy loss	$V_{CE} = 900V$		720		mJ
t <sub>d(on)</sub>	Turn-on delay time	$R_{G(ON)} = 1.5\Omega$		400		ns
tr	Rise time	R <sub>G(OFF)</sub> = 1.5Ω Ls ~ 100nH		250		ns
Eon	Turn-on energy loss			600		mJ
Qrr	Diode reverse recovery charge	IF = 1600A		600		μC
Irr	Diode reverse recovery current	$V_{CE} = 900V$		1050		А
Erec	Diode reverse recovery energy	dl⊧/dt = 7000A/µs		530		mJ





#### PACKAGE DETAILS

For further package information, please visit our website or contact Customer Services. All dimensions in mm, unless stated otherwise. **DO NOT SCALE.** 



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